

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re Application of:

Akram et al.

Serial No.: 09/652,585

Filed: August 31, 2000

For: PROCESS OF FORMING SOCKET

CONTACTS

Examiner: R. Chang

Group Art Unit: 3729

Attorney Docket No.: 5095.5US

(97-1102.05/US)

CERTIFICATE OF MAILING

I hereby certify that this correspondence along with any attachments referred to or identified as being attached or enclosed is being deposited with the United States Postal Service as First Class Mail (under 37 C.F.R. § 1.8(a)) on the date of deposit shown below with sufficient postage and in an envelope addressed to the Commissioner for Patents, Washington, D.C. 20231.

May 27, 2003 Date of Deposit

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Deidra Pfeil
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SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents Washington, D.C. 20231

Sir:

In compliance with the duty to disclose information material to patentability pursuant to 37 C.F.R. § 1.56, it is respectfully requested that this Supplemental Information Disclosure Statement be entered and the documents listed on attached Form PTO-1449 or PTO/SB/08A be considered by the Examiner and made of record. The listed documents are from co-pending application Serial No. 09/652,923, filed August 31, 2000, Serial No. 09/265,906, filed March 10, 1999 and Serial No. 10/121,176, filed April 11, 2002. Copies of the listed documents are enclosed pursuant to 37 C.F.R. § 1.98(a).

In accordance with 37 C.F.R. § 1.97(g) and (h), filing of this Supplemental Information Disclosure Statement is not to be construed as a representation that a search has been made or an admission that the information cited herein is, or is considered to be, material to patentability as defined in 37 C.F.R. § 1.56(b). Further, no representation is made by Applicants herein that no other possible material information as defined in 37 C.F.R. § 1.56(b) exists.

DOCUMENTS

U.S. Patent Documents

U.S. Patent No.	Issue Date	Inventor
5,741,741	04/1998	Tseng
6,049,977	04/2000	Atkins
6,092,282	07/2000	Roberts
6,397,460	06/2002	Hembree

Other Documents

Smith, "Circuits, Devices and Systems" Fourth Edition, 1984.

Applicants offer to supply any explanation or discussion of the documents which the Examiner feels is necessary or desirable and which is requested.

This Supplemental Information Disclosure Statement is filed after the mailing date of the first Office Action on the merits. I hereby certify that no item of information contained in the Supplemental Information Disclosure Statement was cited in a communication from a foreign

patent office in a counterpart foreign application or, to the knowledge of the undersigned after making reasonable inquiry, was known to any individual designated in 37 C.F.R. § 1.56(c) more than three months prior to the filing of the statement.

Respectfully submitted,

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Date: May 27, 2003

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Enclosures: Form PTO-1449 or PTO/SB/08A

Copy of documents cited

Application Numb Docket Number (Optional) INFORMATION DISCLOSURE CITATION 5095.5US (97-1102.05/US) 09/652,585 Applicant Akram et al. IN AN APPLICATION Filing Date August 31, 2000 (Use several sheets if necessary) Group Art Unit 3729 **U.S. PATENT DOCUMENTS** EXAMINER INITIAL DOCUMENT NUMBER FILING DATE DATE NAME CLASS SUBCLASS IF APPROPRIATE 04/1998 5,741,741 Tseng 6,049,977 04/2000 **Atkins** 07/2000 6,092,282 Roberts 6,397,460 06/2002 Hembree **FOREIGN PATENT DOCUMENTS** DOCUMENT SUBCLASS COUNTRY CLASS DATE NO **OTHER DOCUMENTS** (Including Author, Title, Date, Pertinent Pages, Etc.) Smith, "Circuits, Devices and Systems" Fourth Edition, 1984. DATE CONSIDERED **EXAMINER** EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP § 609; Draw line through citation if

not in conformance and not considered. Include copy of this form with next communication to the applicant.